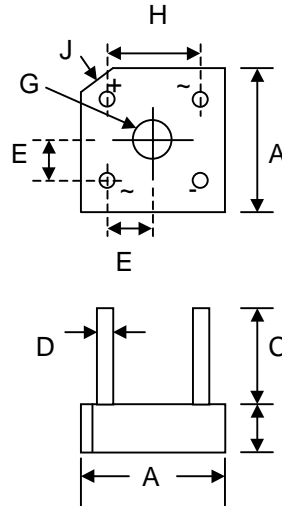


Features

- Diffused Junction
- High Current Capability
- High Case Dielectric Strength
- High Surge Current Capability
- Ideal for Printed Circuit Board Application
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-O



KBPC-8		
Dim	Min	Max
A	18.54	19.56
B	6.35	7.60
C	19.00	—
D	1.27 Ø Typical	
E	5.33	7.37
G	Hole for #6 screw	
	3.60	4.00
H	12.20	13.20
J	2.38 x 45° Typical	
All Dimensions in mm		

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Weight: 5.4 grams (approx.)
- Mounting Position: Through Hole for #6 Screw
- Mounting Torque: 5.0 Inch-pounds Maximum
- Marking: Type Number

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	PB 1000	PB 1001	PB 1002	PB 1004	PB 1006	PB 1008	PB 1010	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ $T_C = 50^\circ\text{C}$	I_O	10							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	150							A
Forward Voltage (per element) @ $I_F = 5.0\text{A}$	V_{FM}	1.1							V
Peak Reverse Current @ $T_C = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_C = 100^\circ\text{C}$	I_R	10 1.0							μA mA
I^2t Rating for Fusing ($t < 8.3\text{ms}$) (Note 2)	I^2t	64							A^2s
Typical Junction Capacitance (Note 3)	C_j	110							pF
Typical Thermal Resistance (Note 4)	$R_{\theta JC}$	7.5							K/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +125							$^\circ\text{C}$

- Note: 1. Mounted on metal chassis.
 2. Non-repetitive, for $t > 1\text{ms}$ and $< 8.3\text{ms}$.
 3. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.
 4. Thermal resistance junction to case per element.

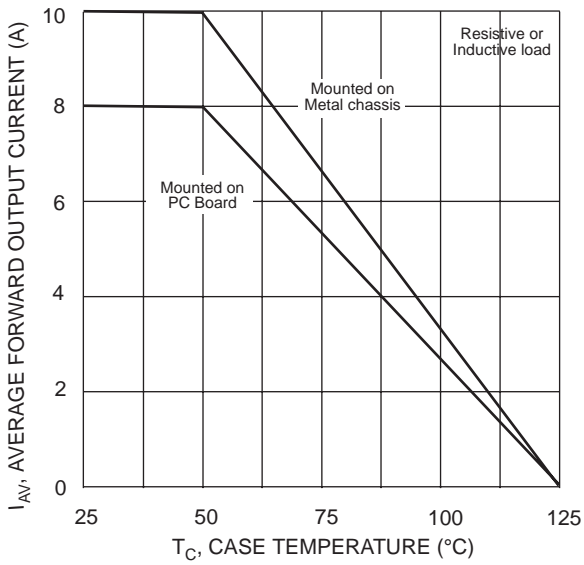


Fig. 1 Forward Current Derating Curve

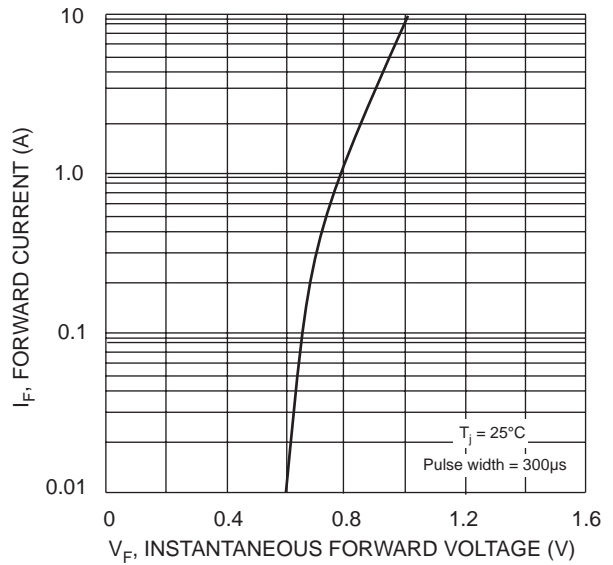


Fig. 2 Typical Forward Characteristics, per element

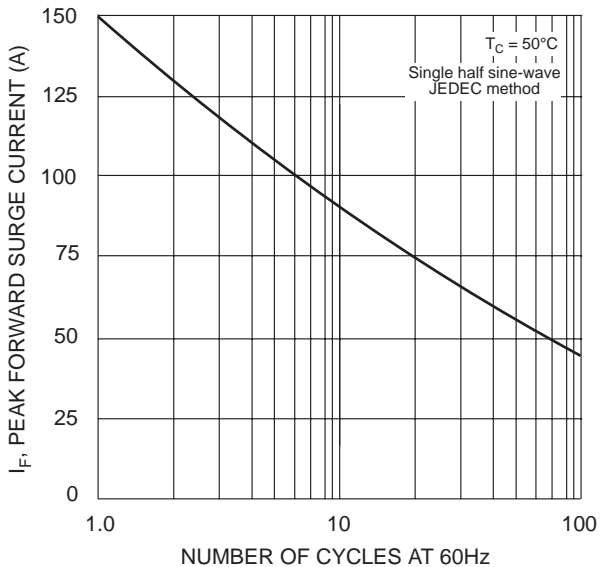


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

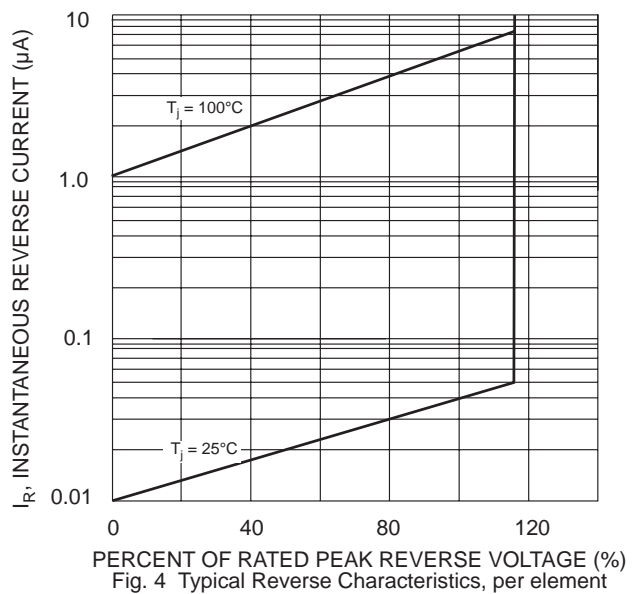


Fig. 4 Typical Reverse Characteristics, per element

ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
PB1000	Square Bridge	200 Units/Box
PB1001	Square Bridge	200 Units/Box
PB1002	Square Bridge	200 Units/Box
PB1004	Square Bridge	200 Units/Box
PB1006	Square Bridge	200 Units/Box
PB1008	Square Bridge	200 Units/Box
PB1010	Square Bridge	200 Units/Box

Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.

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Won-Top Electronics Co., Ltd.

No. 44 Yu Kang North 3rd Road, Chine Chen Dist., Kaohsiung, Taiwan

Phone: 886-7-822-5408 or 886-7-822-5410

Fax: 886-7-822-5417

Email: sales@wontop.com

Internet: <http://www.wontop.com>

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